

(19) United States

(12) Patent Application Publication (10) Pub. No.: US 2023/0232400 A1 CAO et al.

(43) **Pub. Date:**

Jul. 20, 2023

TECHNIQUES FOR CONFIGURING SUPPLEMENTARY DOWNLINK SUPPORT FOR HALF-DUPLEX UE

(71) Applicant: QUALCOMM Incorporated, San

Diego, CA (US)

(72) Inventors: Yiqing CAO, Beijing (CN); Jing LEI,

San Diego, CA (US); Wanshi CHEN, San Diego, CA (US); Peter GAAL, San

Diego, CA (US)

(21) Appl. No.: 17/928,887

(22) PCT Filed: Jun. 26, 2020

(86) PCT No.: PCT/CN2020/098314

§ 371 (c)(1),

(2) Date: Nov. 30, 2022

Publication Classification

(51) Int. Cl. H04W 72/1273 (2006.01)H04L 5/14 (2006.01)

H04W 72/542 (2006.01)H04W 56/00 (2006.01)

(52) U.S. Cl.

CPC H04W 72/1273 (2013.01); H04L 5/14 (2013.01); H04W 56/001 (2013.01);

H04W 72/542 (2023.01)

ABSTRACT (57)

Aspects of the present disclosure provide techniques configuring half duplex UEs (HD-UEs) to implement supplementary downlink (SDL) in band combination that may be in same or different frequency range designations (e.g., FR1 or FR2). Particularly, in order to compensate for the loss of downlink coverage and improve load balancing, aspects of the present disclosure configure the UE to perform random-access channel (RACH), a procedure that is a shared channel used by wireless terminals to access the mobile network, on the anchor carrier in time division duplex (TDD) band and after initial access, the UE may be configured to switch to SDL to receive subsequent downlink signals.

